Preferred Devices

Surface Mount Schottky Power Rectifier

Plastic SOD-123 Package

The MBR0530T1/3 uses the Schottky Barrier principle with a large area metal—to—silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. These state—of—the—artdevices have the following features:

Features

- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL 94, V-0 @ 0.125 in
- Package Designed for Optimal Automated Board Assembly
- Pb-Free Packages are Available

Mechanical Characteristics

• Reel Options: MBR0530T1 = 3,000 per 7 in reel/8 mm tapeMBR0530T3 = 10,000 per 13 in reel/8 mm tape

• Polarity Designator: Cathode Band

• Weight: 11.7 mg (approximately)

• Case: Epoxy, Molded

• Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable

• Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$egin{array}{c} V_{RRM} \ V_{RWM} \ V_{R} \end{array}$	30	V
Average Rectified Forward Current (Rated V _R , T _L = 100°C)	I _{F(AV)}	0.5	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	5.5	А
Storage Temperature Range	T _{stg}	-65 to +150	°C
Operating Junction Temperature	TJ	-65 to +125	°C
Voltage Rate of Change (Rated V _R)	dv/dt	1000	V/μs
ESD Rating: Machine Model = C Human Body Model = 3B		> 400 > 8000	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 0.5 AMPERES 30 VOLTS



SOD-123 CASE 425 STYLE 1

MARKING DIAGRAM



B3 = Device Code M = Date Code

■ = Pb-Free Package (Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

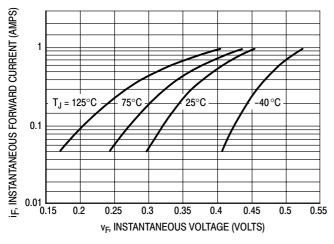
THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance – Junction–to–Ambient (Note 1)	$R_{\theta JA}$	206	°C/W
Thermal Resistance – Junction–to–Lead	$R_{ heta JL}$	150	°C/W

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 2) ($i_F = 0.1 \text{ Amps}, T_J = 25^{\circ}\text{C}$) ($i_F = 0.5 \text{ Amps}, T_J = 25^{\circ}\text{C}$)	VF	0.375 0.43	V
Maximum Instantaneous Reverse Current (Note 2) (Rated DC Voltage, $T_C = 25^{\circ}C$) ($V_R = 15 \text{ V}$, $T_C = 25^{\circ}C$)	I _R	130 20	μΑ

- 1. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.
- 2. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2%.



104 (VI) 1000 T_J = 125°C 10 75°C 10 0 5 10 15 20 25 30 35 40 V_R, REVERSE VOLTAGE (VOLTS)

Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

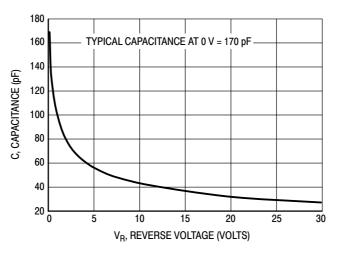
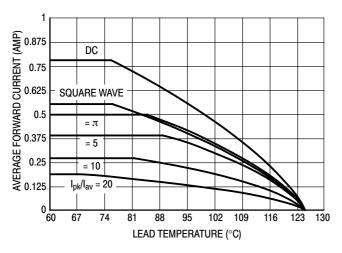


Figure 3. Typical Capacitance



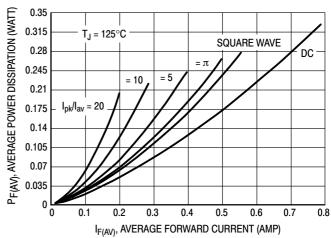


Figure 4. Current Derating (Lead)

Figure 5. Power Dissipation

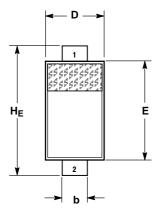
ORDERING INFORMATION

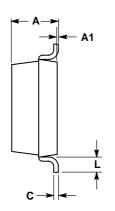
Device	Package	Shipping [†]
MBR0530T1	SOD-123	3000 / Tape & Reel
MBR0530T1G	SOD-123 (Pb-Free)	3000 / Tape & Reel
MBR0530T3	SOD-123	10,000 Tape & Reel
MBR0530T3G	SOD-123 (Pb-Free)	10,000 Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

SOD-123 CASE 425-04 ISSUE E





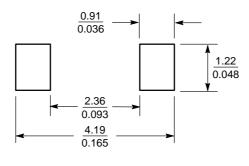
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
 Y14 5M 1982
- 2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.94	1.17	1.35	0.037	0.046	0.053
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.51	0.61	0.71	0.020	0.024	0.028
C			0.15			0.006
D	1.40	1.60	1.80	0.055	0.063	0.071
E	2.54	2.69	2.84	0.100	0.106	0.112
HE	3.56	3.68	3.86	0.140	0.145	0.152
L	0.25			0.010		

STYLE 1: PIN 1. CATHODE 2. ANODE

SOLDERING FOOTPRINT*



SCALE 10:1 $\left(\frac{\text{mm}}{\text{inches}}\right)$

*For additional information on our Pb—Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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